

2mm ELEVATED SOCKET ESQT SERIES

SPECIFICATIONS

For complete specifications see www.samtec.com?ESQT

Insulator Material:
Black Liquid Crystal Polymer

Contact Material:
Phosphor Bronze

Plating:

Sn or Au over 50µ" (1,27µm) Ni

Current Rating:
3A @ 80°C ambient

Operating Temp Range:
-55°C to +125°C

Contact Resistance:
10 mΩ max

Insertion Depth:
(2,62mm) .103" to (5,03mm) .198" with (0,38mm) .015" wiper

Max Cycles:
100 with 10µ" (0,25µm) Au

Insertion Force:
(Single contact only) 4oz (1,11N) avg.

Withdrawal Force:
(Single contact only) 3oz (0,83N) avg.

RoHS Compliant:
Yes

Processing:

Max Processing Temp:
230°C for 60 seconds, or 260°C for 20 seconds 3x for -S, -D & -Q (230°C for 60 seconds only for -T, -5 & -6)

Lead-Free Solderable:
Yes, for -S, -D & -Q (Wave only for -T, -5 & -6)

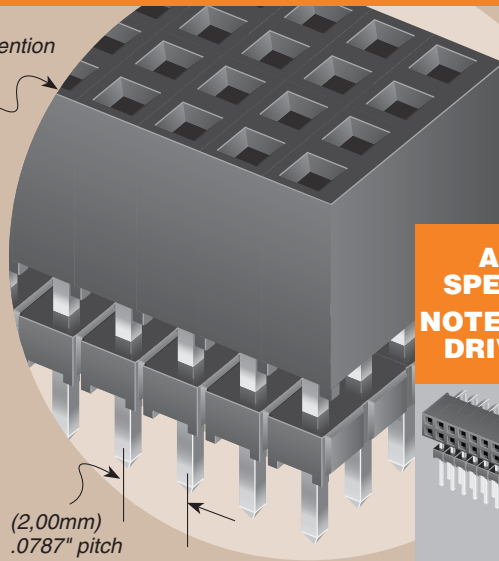


AMBIENT TEMP	CURRENT RATING
20°C	5.5A
40°C	5A
60°C	4A
80°C	3A

Mates with:
TMMH, TMM, MTMM, MMT, TW, LTMM, ZLTMM, ESQT, TCMD



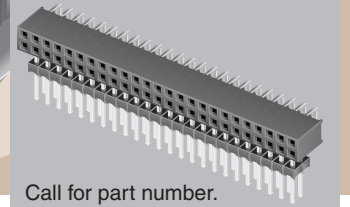
High Retention Contacts



(2,00mm) .0787" pitch

Note: This Series is non-standard, non-returnable.

APPLICATION SPECIFIC OPTION:
NOTEBOOK 2.5" DISK DRIVE INTERFACE



Call for part number.

ESQT	1	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	ROW OPTION	BODY HEIGHT	OTHER OPTION
		02 thru 50	Specify LEAD STYLE from chart	-G = 20µ" (0,51µm) Gold (Recommended for self-nesting) -M = 20µ" (0,51µm) Gold on contact, Matte Tin on tail -L = 10µ" (0,25µm) Gold on contact, Matte Tin on tail -F = Gold flash on contact, Matte Tin on tail	-S = Single Row -D = Double Row -T = Triple Row -Q = Quad Row -5 = Five Row -6 = Six Row	-"XXX" = Body Height (in inches) (7,87mm) .310" minimum for -S, -D, -Q (9,53mm) .375" minimum for -T, -5, -6	-"XXX" = Polarized Position (Indicate position number)

Also Available

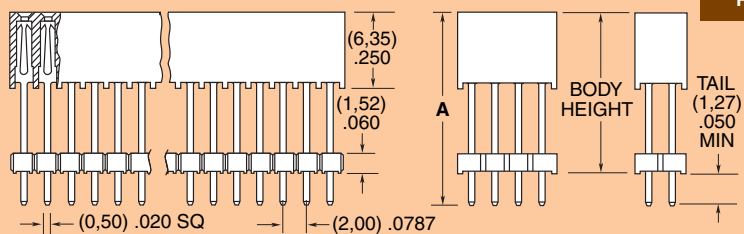
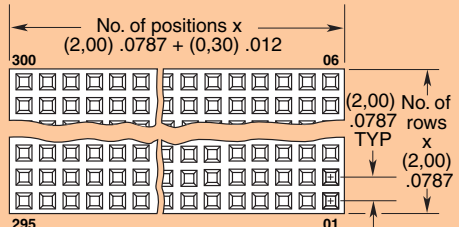
Surface Mount
See SQW and TLE Series.

Low Profile
See CLT Series.

High Reliability
See SMM Series.

Right Angle
See SQW Series.

PC104+ Sockets
See ESQT-368 and PTHF Series.



LEAD STYLE	A	MAX TAIL	MAX BODY HEIGHT
-02	(21,59) .850	(13,72) .540	(20,32) .800
-03	(11,63) .458	(3,76) .148	(10,36) .408

ALSO AVAILABLE

Paste In Hole (PIH) processing. Contact Samtec ASP Group. (Not recommended for stack through applications)

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM